



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
PATENT APPLICATION

0420
2/9/01
0300

In re Application of
Eng et al.

Serial No: **09/766,477**

Filed: **01/19/01**

For: **VERTICAL BALL GRID ARRAY INTEGRATED CIRCUIT PACKAGE**

Docket: **TI-22944.2**

Art Unit: **TBD**

Examiner: **TBD**

SECOND PRELIMINARY AMENDMENT

Assistant Commissioner for
Patents
Washington, D. C. 20231

Sir:

MAILING CERTIFICATE UNDER 37 C.F.R. §1.8(a)

I hereby certify that the above correspondence is being deposited with the U.S. Postal Service as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231 on

3-6-01

Jackie McBride
Jackie McBride

Prior to examination in this case, please disregard the request to cancel claims 22-27 and instead cancel claims 11-20.

REMARKS

The above amendment is to correct an error. Claims 11-20 were elected in application serial no. 09/478,917. Favorable action and allowance of the application are respectfully requested.

Respectfully submitted,

Wade James Brady III

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